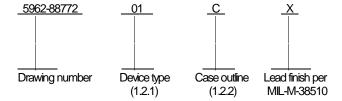
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1. SCOPE

1.1 Scope. This drawing describes device requirements for class B microcircuits in accordance with 1.2.1 of MIL-STD-883, "Provisions for the use of MIL-STD-883 in conjunction with compliant non-JAN devices".

1.2 Part number. The complete part number shall be as shown in the following example:



1.2.1 <u>Device type</u>. The device type shall identify the circuit function as follows:

<u>Device type</u>	Generic number	<u>Circuit function</u>
01	ICL8038	Precision waveform generator/voltage

1.2.2 <u>Case outline</u>. The case outline shall be as designated in appendix C of MIL-M-38510, and as follows:

Outline letter	Case outline

C D-1 (14-lead, .785" x .310" x .200"), dual-in-line package

1.3 Absolute maximum ratings.

Lead temperature (soldering, 10 seconds) +300 $^{\circ}$ C
Power dissipation (P_D) 750 mW 1/

Thermal resistance, junction-to-case (O_{JC}) See MIL-M-38510, appendix C

Junction temperature (T_i)+150°C

1.4 Recommended operating conditions.

 $\overline{1/D}$ Derate above $T_A = +100^{\circ}$ C at 12.5 mW/ $^{\circ}$ C.

STANDARDIZED MILITARY DRAWING	SIZE A		5962-88772
DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO 45444		REVISION LEVEL	SHEET 2

2. APPLICABLE DOCUMENTS

2.1 <u>Government specification and standard</u>. Unless otherwise specified, the following specification and standard, of the issue listed in that issue of the Department of Defense Index of Specifications and Standards specified in the solicitation, form a part of this drawing to the extent specified herein.

SPECIFICATION

MILITARY

MIL-M-38510

- Microcircuits, General Specification for.

STANDARD

MILITARY

MIL-STD-883

- Test Methods and Procedures for Microelectronics.

(Copies of the specification and standard required by manufacturers in connection with specific acquisition functions should be obtained from the contracting activity or as directed by the contracting activity.)

- 2.2 Order of precedence. In the event of a conflict between the text of this drawing and the references cited herein, the text of this drawing shall take precedence.
- 3. REQUIREMENTS
- 3.1 <u>Item requirements</u>. The individual item requirements shall be in accordance with 1.2.1 of MIL-STD-883, "Provisions for the use of MIL-STD-883 in conjunction with compliant non-JAN devices" and as specified herein.
- 3.2 Design, construction, and physical dimensions. The design, construction, and physical dimensions shall be as specified in MIL-M-38510 and herein.
- 3.2.1 Terminal connections. The terminal connections shall be as specified on figure 1.
- 3.2.2 Functional diagram. The functional diagram shall be as specified on figure 2.
- 3.2.3 Case outline. The case outline shall be in accordance with 1.2.2 herein.
- 3.3 <u>Electrical performance characteristics</u>. Unless otherwise specified herein, the electrical performance characteristics are as specified in table I and apply over the full ambient operating temperature range.
- 3.4 <u>Marking</u>. Marking shall be in accordance with MIL-STD-883 (see 3.1 herein). The part shall be marked with the part number listed in 1.2 herein. In addition, the manufacturer's part number may also be marked as listed in 6.4 herein
- 3.5 <u>Certificate of compliance</u>. A certificate of compliance shall be required from a manufacturer in order to be listed as an approved source of supply in 6.4. The certificate of compliance submitted to DESC-ECS prior to listing as an approved source of supply shall affirm that the manufacturer's product meets the requirements of MIL-STD-883 (see 3.1 herein) and the requirements herein.
- 3.6 <u>Certificate of conformance</u>. A certificate of conformance as required in MIL-STD-883 (see 3.1 herein) shall be provided with each lot of microcircuits delivered to this drawing.

STANDARDIZED MILITARY DRAWING DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO 45444	SIZE A		5962-88772
		REVISION LEVEL	SHEET 3

Test	Symbol	Conditions 1/	Group A	Limit	S	Unit
		-55° C≤ T _A ≤ +125° C unless otherwise specified	subgroups	Min	Max	
General characteristics	·	•	·			•
Supply voltage range, single voltage <u>2</u> /	V+		1,2,3	+10	+30	V
Supply voltage range, dual supply <u>2</u> /	V+		1,2,3	+5.0	+15	V
and coppy =	V-			-5.0	-15	
Supply current	I _{SUP}	V _{SUP} =±10 V, R _A and R _B currents not included	1		15	mA
			2,3		24	
Frequency characteristics (all wa	veforms)					*
Maximum frequency of oscillation	f _{MAX}		7,8A,8B	100		kHz
Frequency drift with temperature	<u>∆</u> f ∆⊤	Pins 7 and 9 connected, V _{SUP} = ±10 V	4,5		250	ppn °C
			6		350	
Frequency drift with supply voltage	<u>Δf</u> ΔV _{SUP}	Over supply voltage range	4,5,6		0.5	% ∧
Supply Vollage						

See footnotes at end of table.

STANDARDIZED MILITARY DRAWING DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO 45444	SIZE A		5962-88772
		REVISION LEVEL	SHEET 4

Test	Symbol	Conditions 1/	Group A	Limits		Unit	
		-55° C ≤ T_{A} ≤+125 $^{\circ}$ C unless otherwise specified	subgroups	Min	Max		
Output characteristics	'		,			·	
Square wave leakage current	louk	Voltage at square wave out = 30 V _{P-P}	1,3		1.0	μΑ	
			2		5.0		
Square wave saturation voltage	V _{SAT}	I _{SINK} =2.0 mA	1	0.4		V	
			2	0.6			
			3	0.5			
Duty cycle adjust <u>2</u> /	ΔD		1,2,3	5.0	95.0	%	
Triangle/sawtooth/ramp amplitude	V _{T/S/R}	R _{TRI} =100 kΩ	1,2,3	0.30 xV _{SUP}		V _{P-l}	
Sine-wave amplitude	V _{SINE}	$R_{SINE} = 100 k\Omega$	1,2,3	0.2 xV _{SUP}		V _{P-l}	
Total harmonic distortion	THD	$R_S = 1.0 \text{M}\Omega 3/$	4		1.5	%	
			5,6 <u>2</u> /		3.5		

 $[\]underline{1}/\ V_{SUP}$ = ±10 V or +20 V unless otherwise specified. See test circuit on figure 3.

STANDARDIZED MILITARY DRAWING	SIZE A		5962-88772
DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO 45444		REVISION LEVEL	SHEET 5

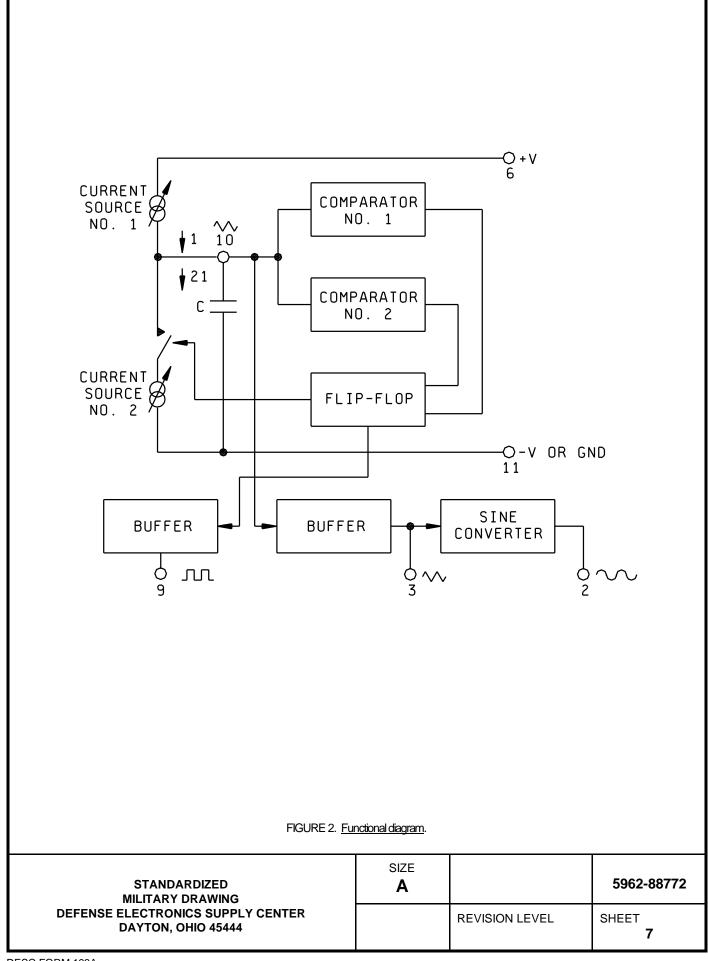
 $[\]underline{\textit{2}}\!\!/$ If not tested, shall be guaranteed to the limits specified in table I.

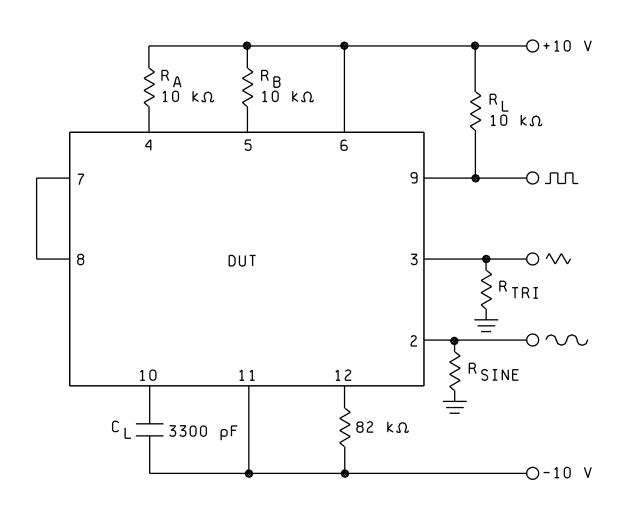
 $[\]underline{3}$ / 82 k Ω connected between pins 11 and 12, triangle duty cycle set at 50 percent (use R $_A$ and R $_B$).

Device type	01
Case outline	С
Terminal number	Terminal symbol
1 2 3 4 5 6 7 8 9 10 11 12 13	Sine wave adjust Sine wave out Triangle out Duty cycle frequency adjust Duty cycle frequency adjust +V FM bias FM sweep input Square wave out Timing capacitor -V or GND Sine wave adjust NC NC

FIGURE 1. <u>Terminal connections</u>.

STANDARDIZED MILITARY DRAWING	SIZE A		5962-88772
DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO 45444		REVISION LEVEL	SHEET 6





NOTES:

- 1. R_L is not used for leakage current and saturation voltage testing. During these tests, oscillation can be halted by forcing pin 10 to +5.0 V or -5.0 V.
- 2. Output amplitude is tested under static conditions by forcing pin 10 to +5.0 V then to -5.0 V.

FIGURE 3. Test circuit.

STANDARDIZED MILITARY DRAWING DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO 45444	SIZE A		5962-88772
		REVISION LEVEL	SHEET 8

- 3.7 Notification of change. Notification of change to DESC-ECS shall be required in accordance with MIL-STD-883 (see 3.1 herein).
- 3.8 <u>Verification and review</u>. DESC, DESC's agent, and the acquiring activity retain the option to review the manufacturer's facility and applicable required documentation. Offshore documentation shall be made available onshore at the option of the reviewer.
- 4. QUALITY ASSURANCE PROVISIONS
- 4.1 <u>Sampling and inspection</u>. Sampling and inspection procedures shall be in accordance with section 4 of MIL-M-38510 to the extent specified in MIL-STD-883 (see 3.1 herein).
- 4.2 <u>Screening</u>. Screening shall be in accordance with method 5004 of MIL-STD-883, and shall be conducted on all devices prior to quality conformance inspection. The following additional criteria shall apply:
 - a. Burn-in test, method 1015 of MIL-STD-883:
 - (1) Test condition A, B, C, or D using the circuit submitted with the certificate of compliance (see 3.5 herein).
 - (2) $T_A = +125^{\circ}C$, minimum.
 - b. Interim and final electrical test parameters shall be as specified in table II herein, except interim electrical parameter tests prior to burn-in are optional at the discretion of the manufacturer.
- 4.3 <u>Quality conformance inspection</u>. Quality conformance inspection shall be in accordance with method 5005 of MIL-STD-883 including groups A, B, C, and D inspections. The following additional criteria shall apply.
- 4.3.1 Group A inspection.

Tests shall be as specified in table II herein.

- 4.3.2 Groups C and D inspections.
 - a. End-point electrical parameters shall be as specified in table II herein.
 - b. Steady-state life test conditions, method 1005 of MIL-STD-883:
 - (1) Test condition A, B, C, or D using the circuit submitted with the certificate of compliance (see 3.5 herein).
 - (2) $T_A = +125^{\circ}C$, minimum.
 - (3) Test duration: 1,000 hours, except as permitted by method 1005 of MIL-STD-883.

STANDARDIZED MILITARY DRAWING DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO 45444	SIZE A		5962-88772
		REVISION LEVEL	SHEET 9

TABLE II. Electrical test requirements.

MIL-STD-883 test requirements	Subgroups (per method 5005, table I)
Interim electrical parameters (method 5004)	1
Final electrical test parameters (method 5004)	1*,2,3,4,5,6,7, 8A,8B,9,10,11
Group A test requirements (method 5005)	1*,2,3,4,5,6,7, 8A,8B,9,10,11
Groups C and D end-point electrical parameters (method 5005)	1

^{*} PDA applies to subgroup 1.

- 5. PACKAGING
- 5.1 Packaging requirements. The requirements for packaging shall be in accordance with MIL-M-38510.
- 6. NOTES
- 6.1 Intended use. Microcircuits conforming to this drawing are intended for use when military specifications do not exist and qualified military devices that will perform the required function are not available for OEM application. When a military specification exists and the product covered by this drawing has been qualified for listing on QPL-38510, the device specified herein will be inactivated and will not be used for new design. The QPL-38510 product shall be the preferred item for all applications.
- 6.2 Replaceability. Microcircuits covered by this drawing will replace the same generic device covered by a contractor-prepared specification or drawing.
- 6.3 Comments. Comments on this drawing should be directed to DESC-ECS, Dayton, Ohio 45444, or telephone 513-296-5375.

STANDARDIZED		
MILITARY DRAWING		
DEFENSE ELECTRONICS SUPPLY CENTER		
DAYTON, OHIO 45444		

SIZE A		5962-88772
	REVISION LEVEL	SHEET 10

6.4 <u>Approved source of supply</u>. An approved source of supply is listed herein. Additional sources will be added as they become available. The vendor listed herein has agreed to this drawing and a drawing and a certificate of compliance (see 3.5 herein) has been submitted to DESC-ECS.

Military drawing part number	Vendor CAGE number	Vendor similar part number <u>1</u> /
5962-8877201CX	32293	ICL8038AMJD/883B

1/ Caution. Do not use this number for item acquisition. Items acquired by this number may not satisfy the performance requirements of this drawing.

Vendor CAGE <u>number</u> Vendor name and address

32293

Intersil, Incorporated 2450 Walsh Avenue Santa Clara, CA 95051

STANDARDIZED
MILITARY DRAWING
DEFENSE ELECTRONICS SUPPLY CENTER
DAYTON, OHIO 45444

SIZE A		5962-88772
	REVISION LEVEL	SHEET 11